

Please read this notice before using the TAIYO YUDEN products.

REMINDERS

- Product information in this catalog is as of October 2018. All of the contents specified herein are subject to change without notice due to technical improvements, etc. Therefore, please check for the latest information carefully before practical application or use of our products.

Please note that TAIYO YUDEN shall not be in any way responsible for any damages and defects in products or equipment incorporating our products, which are caused under the conditions other than those specified in this catalog or individual product specification sheets.

- Please contact TAIYO YUDEN for further details of product specifications as the individual product specification sheets are available.
- Please conduct validation and verification of our products in actual condition of mounting and operating environment before using our products.
- The products listed in this catalog are intended for use in general electronic equipment (e.g., AV equipment, OA equipment, home electric appliances, office equipment, information and communication equipment including, without limitation, mobile phone, and PC) and medical equipment classified as Class I or II by IMDRF. Please be sure to contact TAIYO YUDEN for further information before using the products for any equipment which may directly cause loss of human life or bodily injury (e.g., transportation equipment including, without limitation, automotive powertrain control system, train control system, and ship control system, traffic signal equipment, disaster prevention equipment, medical equipment classified as Class III by IMDRF, highly public information network equipment including, without limitation, telephone exchange, and base station).

Please do not incorporate our products into any equipment requiring high levels of safety and/or reliability (e.g., aerospace equipment, aviation equipment*, medical equipment classified as Class IV by IMDRF, nuclear control equipment, undersea equipment, military equipment).

*Note: There is a possibility that our products can be used only for aviation equipment that does not directly affect the safe operation of aircraft (e.g., in-flight entertainment, cabin light, electric seat, cooking equipment) if such use meets requirements specified separately by TAIYO YUDEN. Please be sure to contact TAIYO YUDEN for further information before using our products for such aviation equipment.

When our products are used even for high safety and/or reliability-required devices or circuits of general electronic equipment, it is strongly recommended to perform a thorough safety evaluation prior to use of our products and to install a protection circuit as necessary.

Please note that unless you obtain prior written consent of TAIYO YUDEN, TAIYO YUDEN shall not be in any way responsible for any damages incurred by you or third parties arising from use of the products listed in this catalog for any equipment requiring inquiry to TAIYO YUDEN or prohibited for use by TAIYO YUDEN as described above.

- Information contained in this catalog is intended to convey examples of typical performances and/or applications of our products and is not intended to make any warranty with respect to the intellectual property rights or any other related rights of TAIYO YUDEN or any third parties nor grant any license under such rights.
- Please note that the scope of warranty for our products is limited to the delivered our products themselves and TAIYO YUDEN shall not be in any way responsible for any damages resulting from a fault or defect in our products. Notwithstanding the foregoing, if there is a written agreement (e.g., supply and purchase agreement, quality assurance agreement) signed by TAIYO YUDEN and your company, TAIYO YUDEN will warrant our products in accordance with such agreement.
- The contents of this catalog are applicable to our products which are purchased from our sales offices or authorized distributors (hereinafter "TAIYO YUDEN's official sales channel"). Please note that the contents of this catalog are not applicable to our products purchased from any seller other than TAIYO YUDEN's official sales channel.
- Caution for Export
Some of our products listed in this catalog may require specific procedures for export according to "U.S. Export Administration Regulations", "Foreign Exchange and Foreign Trade Control Law" of Japan, and other applicable regulations. Should you have any questions on this matter, please contact our sales staff.

METAL CORE WIRE-WOUND CHIP POWER INDUCTORS(MCOIL™ MA-H SERIES)



REFLOW

PARTS NUMBER

* Operating Temp.: -40~+125°C (Including self-generated heat)

* Operating Temp.: -40~+105°C (Including self-generated heat) ※1Parts Number reference

M	A	K	K	2	0	1	6	H	1	R	0	M	△	△
①	②	③	④	⑤	⑥	⑦	⑧							

△=Blank space

①Series name

Code	Series name
MA	Metal Core Wire-wound Chip Power Inductor

②Dimensions (T)

Code	Dimensions (T) [mm]
KK	1.0
MK	1.2

③Dimensions (L × W)

Code	Dimensions (L × W) [mm]
2016	2.0 × 1.6
2520	2.5 × 2.0

④Packaging

Code	Packaging or Special specification
H	Taping (High characteristics)

⑤Nominal inductance

Code (example)	Nominal inductance [μH]
R47	0.47
1R0	1.0
4R7	4.7

※R=Decimal point

⑥Inductance tolerance

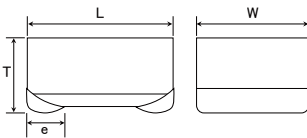
Code	Inductance tolerance
M	±20%

⑦Special code

Code	Special code
△	Standard

⑧Internal code

STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY

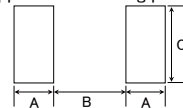


Recommended Land Patterns

Surface Mounting

• Mounting and soldering conditions should be checked beforehand.

• Applicable soldering process to these products is reflow soldering only.



Type	A	B	C
2016	0.7	0.8	1.8
2520	0.8	1.2	2.0

Unit: mm

Type	L	W	T	e	Standard quantity [pcs] Taping
MAKK2016H	2.0±0.1 (0.079±0.004)	1.6±0.1 (0.063±0.004)	1.0 max (0.039 max)	0.5±0.3 (0.020±0.012)	3000
MAKK2520H	2.5±0.2 (0.098±0.008)	2.0±0.2 (0.079±0.008)	1.0 max (0.039 max)	0.5±0.3 (0.020±0.012)	3000
MAMK2520H	2.5±0.2 (0.098±0.008)	2.0±0.2 (0.079±0.008)	1.2 max (0.047 max)	0.5±0.3 (0.020±0.012)	3000

Unit: mm (inch)

► This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our product specification sheets. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our website (<http://www.ty-top.com/>).

● MAKK2016H type [Thickness: 1.0mm max.]

Parts number	EHS	Nominal inductance [μ H]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (max.)	Rated current ※) [mA] (max.)		Measuring frequency [MHz]
						Saturation current Idc1	Temperature rise current Idc2	
MAKK2016HR22M	RoHS	0.22	$\pm 20\%$	-	0.026	5,800	4,000	2
MAKK2016HR24M	RoHS	0.24	$\pm 20\%$	-	0.026	5,800	4,000	2
MAKK2016HR33M	RoHS	0.33	$\pm 20\%$	-	0.030	4,700	3,500	2
MAKK2016HR47M	RoHS	0.47	$\pm 20\%$	-	0.036	4,300	3,300	2
MAKK2016HR68M	RoHS	0.68	$\pm 20\%$	-	0.050	3,200	2,700	2
MAKK2016H1R0M	RoHS	1.0	$\pm 20\%$	-	0.070	2,700	2,300	2
MAKK2016H1R5M	RoHS	1.5	$\pm 20\%$	-	0.105	2,100	1,800	2

● MAKK2520H type [Thickness: 1.0mm max.]

Parts number	EHS	Nominal inductance [μ H]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (max.)	Rated current ※) [mA] (max.)		Measuring frequency [MHz]
						Saturation current Idc1	Temperature rise current Idc2	
MAKK2520HR22M	RoHS	0.22	$\pm 20\%$	-	0.021	7500	4900	2
MAKK2520HR33M	RoHS	0.33	$\pm 20\%$	-	0.026	6200	4300	2
MAKK2520HR47M	RoHS	0.47	$\pm 20\%$	-	0.029	5700	4000	2
MAKK2520HR68M	RoHS	0.68	$\pm 20\%$	-	0.043	4300	3400	2
MAKK2520H1R0M	RoHS	1.0	$\pm 20\%$	-	0.053	3800	3000	2
MAKK2520H1R5M	RoHS	1.5	$\pm 20\%$	-	0.078	3000	2400	2
MAKK2520H2R2M	RoHS	2.2	$\pm 20\%$	-	0.120	2500	1800	2
MAKK2520H100M ※1	RoHS	10	$\pm 20\%$	-	0.650	1100	750	2

● MAMK2520H type [Thickness: 1.2mm max.]

Parts number	EHS	Nominal inductance [μ H]	Inductance tolerance	Self-resonant frequency [MHz] (min.)	DC Resistance [Ω] (max.)	Rated current ※) [mA] (max.)		Measuring frequency [MHz]
						Saturation current Idc1	Temperature rise current Idc2	
MAMK2520HR22M	RoHS	0.22	$\pm 20\%$	-	0.021	7500	5000	2
MAMK2520HR33M	RoHS	0.33	$\pm 20\%$	-	0.023	6600	4400	2
MAMK2520HR47M	RoHS	0.47	$\pm 20\%$	-	0.026	5800	4100	2
MAMK2520HR68M	RoHS	0.68	$\pm 20\%$	-	0.036	5100	3500	2
MAMK2520H1R0M	RoHS	1.0	$\pm 20\%$	-	0.045	4300	3100	2
MAMK2520H1R5M	RoHS	1.5	$\pm 20\%$	-	0.065	3300	2600	2
MAMK2520H2R2M	RoHS	2.2	$\pm 20\%$	-	0.090	2800	2200	2

※) The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20°C)

※) The temperature rise current value (Idc2) is the DC current value having temperature increase by 40°C. (at 20°C)

※) The rated current value is following either Idc1 or Idc2, which is the lower one.

⑤ Reel size



Type	Reel size (Reference values)		
	ϕD	ϕd	W
MAKK2016	180+0/-3	60+1/-0	10.0±1.5
MAKK2520	(7.087+0/-0.118)	(2.36+0.039/0)	(0.394±0.059)
MAMK2520			

Unit: mm (inch)

⑥ Top Tape Strength

The top tape requires a peel-off force of 0.1 to 1.2N in the direction of the arrow as illustrated below.



► This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (<http://www.ty-top.com/>).

METAL CORE WIRE-WOUND CHIP POWER INDUCTORS (MCOIL™ MA SERIES / MCOIL™ MA-H SERIES)

RELIABILITY DATA

1. Operating Temperature Range		
Specified Value	MA series	-40~+105°C
	MA-H series	-40~+125°C
Test Methods and Remarks	Including self-generated heat	
2. Storage Temperature Range		
Specified Value	MA series	-40~+85°C
	MA-H series	
Test Methods and Remarks	0 to 40°C for the product with taping.	
3. Rated current		
Specified Value	MA series	Within the specified tolerance
	MA-H series	
4. Inductance		
Specified Value	MA series	Within the specified tolerance
	MA-H series	
Test Methods and Remarks	Measuring equipment : LCR Meter (HP 4285A or equivalent) Measuring frequency : 2MHz, 1V	
5. DC Resistance		
Specified Value	MA series	Within the specified tolerance
	MA-H series	
Test Methods and Remarks	Measuring equipment : DC ohmmeter (HIOKI 3227 or equivalent)	
6. Self resonance frequency		
Specified Value	MA series	-
	MA-H series	
7. Temperature characteristic		
Specified Value	MA series	Inductance change : Within ±15%
	MA-H series	
Test Methods and Remarks	Measurement of inductance shall be taken at temperature range within -40°C~+85°C. With reference to inductance value at +20°C., change rate shall be calculated.	
8. Resistance to flexure of substrate		
Specified Value	MA series	No damage
	MA-H series	
Test Methods and Remarks	<p>The test samples shall be soldered to the test board by the reflow. As illustrated below, apply force in the direction of the arrow indicating until deflection of the test board reaches to 2 mm.</p> <p>Test board size : 100 × 40 × 1.0 mm Test board material : Glass epoxy-resin Solder cream thickness : 0.12 mm</p>	



▶ This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification.
 For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (<http://www.ty-top.com/>).

9. Insulation resistance : between wires																
Specified Value	MA series	—														
	MA-H series															
10. Insulation resistance : between wire and core																
Specified Value	MA series	DC25V 100kΩ min														
	MA-H series															
11. Withstanding voltage : between wire and core																
Specified Value	MA series	—														
	MA-H series															
12. Adhesion of terminal electrode																
Specified Value	MA series	No abnormality.														
	MA-H series															
Test Methods and Remarks	<p>The test samples shall be soldered to the test board by the reflow.</p> <p>Applied force : 10N to X and Y directions.</p> <p>Duration : 5s.</p> <p>Solder cream thickness : 0.12mm.</p>															
13. Resistance to vibration																
Specified Value	MA series	Inductance change : Within $\pm 10\%$ No significant abnormality in appearance.														
	MA-H series															
Test Methods and Remarks	<p>The test samples shall be soldered to the test board by the reflow.</p> <p>Then it shall be submitted to below test conditions.</p> <table border="1"> <tr> <td>Frequency Range</td> <td colspan="2">10~55Hz</td> </tr> <tr> <td>Total Amplitude</td> <td colspan="2">1.5mm (May not exceed acceleration 196m/s²)</td> </tr> <tr> <td>Sweeping Method</td> <td colspan="2">10Hz to 55Hz to 10Hz for 1min.</td> </tr> <tr> <td rowspan="3">Time</td> <td>X</td> <td rowspan="3">For 2 hours on each X, Y, and Z axis.</td> </tr> <tr> <td>Y</td> </tr> <tr> <td>Z</td> </tr> </table> <p>Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.</p>		Frequency Range	10~55Hz		Total Amplitude	1.5mm (May not exceed acceleration 196m/s ²)		Sweeping Method	10Hz to 55Hz to 10Hz for 1min.		Time	X	For 2 hours on each X, Y, and Z axis.	Y	Z
	Frequency Range	10~55Hz														
Total Amplitude	1.5mm (May not exceed acceleration 196m/s ²)															
Sweeping Method	10Hz to 55Hz to 10Hz for 1min.															
Time	X	For 2 hours on each X, Y, and Z axis.														
	Y															
	Z															
14. Solderability																
Specified Value	MA series	At least 90% of surface of terminal electrode is covered by new solder.														
	MA-H series															
Test Methods and Remarks	<p>The test samples shall be dipped in flux, and then immersed in molten solder as shown in below table.</p> <p>Flux : Methanol solution containing rosin 25%.</p> <table border="1"> <tr> <td>Solder Temperature</td> <td>245\pm5°C</td> </tr> <tr> <td>Time</td> <td>5\pm0.5 sec.</td> </tr> </table> <p>※Immersion depth : All sides of mounting terminal shall be immersed.</p>		Solder Temperature	245 \pm 5°C	Time	5 \pm 0.5 sec.										
Solder Temperature	245 \pm 5°C															
Time	5 \pm 0.5 sec.															
15. Resistance to soldering heat																
Specified Value	MA series	Inductance change : Within $\pm 10\%$ No significant abnormality in appearance.														
	MA-H series															
Test Methods and Remarks	<p>The test sample shall be exposed to reflow oven at 230°C for 40 seconds, with peak temperature at 260+0/-5°C for 5 seconds, 3 times.</p> <p>Test board material : Glass epoxy-resin</p> <p>Test board thickness : 1.0mm</p> <p>Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.</p>															

16. Thermal shock		
Specified Value	MA series	Inductance change : Within $\pm 10\%$ No significant abnormality in appearance.
	MA-H series	
Test Methods and Remarks	The test samples shall be soldered to the test board by the reflow. The test samples shall be placed at specified temperature for specified time by step 1 to step 4 as shown in below table in sequence. The temperature cycle shall be repeated 100 cycles.	
	Conditions of 1 cycle	
	Step	Temperature ($^{\circ}\text{C}$)
	1	-40 ± 3
	2	Room temperature
	3	$+85 \pm 2$
4	Room temperature	
Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.		Duration (min)
		30 ± 3
		Within 3
		30 ± 3
		Within 3

17. Damp heat		
Specified Value	MA series	Inductance change : Within $\pm 10\%$ No significant abnormality in appearance.
	MA-H series	
Test Methods and Remarks	The test samples shall be soldered to the test board by the reflow.	
	The test samples shall be placed in thermostatic oven set at specified temperature and humidity as shown in below table.	
	Temperature	$60 \pm 2^{\circ}\text{C}$
	Humidity	$90 \sim 95\% \text{RH}$
	Time	$500 + 24 / - 0$ hour
Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.		

18. Loading under damp heat		
Specified Value	MA series	Inductance change : Within $\pm 10\%$ No significant abnormality in appearance.
	MA-H series	
Test Methods and Remarks	The test samples shall be soldered to the test board by the reflow.	
	The test samples shall be placed in thermostatic oven set at specified temperature and humidity and applied the rated current continuously as shown in below table.	
	Temperature	$60 \pm 2^{\circ}\text{C}$
	Humidity	$90 \sim 95\% \text{RH}$
	Applied current	Rated current
	Time	$500 + 24 / - 0$ hour
Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.		

19. Low temperature life test		
Specified Value	MA series	Inductance change : Within $\pm 10\%$ No significant abnormality in appearance.
	MA-H series	
Test Methods and Remarks	The test samples shall be soldered to the test board by the reflow. After that, the test samples shall be placed at test conditions as shown in below table.	
	Temperature	$-40 \pm 2^{\circ}\text{C}$
	Time	$500 + 24 / - 0$ hour
	Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.	

20. High temperature life test		
Specified Value	MA series	Inductance change : Within $\pm 10\%$ No significant abnormality in appearance.
	MA-H series	
Test Methods and Remarks	The test samples shall be soldered to the test board by the reflow. After that, the test samples shall be placed at test conditions as shown in below table.	
	Temperature	$85 \pm 2^{\circ}\text{C}$
	Time	$500 + 24 / - 0$ hour
	Recovery : At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48hrs.	

21. Loading at high temperature life test		
Specified Value	MA series	-
	MA-H series	

22. Standard condition

Specified Value	MA series	Standard test condition : Unless otherwise specified, temperature is $20 \pm 15^{\circ}\text{C}$ and $65 \pm 20\%$ of relative humidity. When there is any question concerning measurement result: In order to provide correlation data, the test shall be condition of $20 \pm 2^{\circ}\text{C}$ of temperature, $65 \pm 5\%$ relative humidity. Inductance is in accordance with our measured value.
	MA-H series	

METAL CORE WIRE-WOUND CHIP POWER INDUCTORS (MCOIL™ MA SERIES / MCOIL™ MA-H SERIES)

■ PRECAUTIONS

1. Circuit Design	
Precautions	<p>◆Operating environment</p> <p>1. The products described in this specification are intended for use in general electronic equipment,(office supply equipment, telecommunications systems, measuring equipment, and household equipment). They are not intended for use in mission-critical equipment or systems requiring special quality and high reliability (traffic systems, safety equipment, aerospace systems, nuclear control systems and medical equipment including life-support systems.) where product failure might result in loss of life, injury or damage. For such uses, contact TAIYO YUDEN Sales Department in advance.</p>
2. PCB Design	
Precautions	<p>◆Land pattern design</p> <p>1. Please refer to a recommended land pattern.</p>
Technical considerations	<p>◆Land pattern design</p> <p>Surface Mounting</p> <ul style="list-style-type: none"> • Mounting and soldering conditions should be checked beforehand. • Applicable soldering process to this products is reflow soldering only.
3. Considerations for automatic placement	
Precautions	<p>◆Adjustment of mounting machine</p> <p>1. Excessive impact load should not be imposed on the products when mounting onto the PC boards.</p> <p>2. Mounting and soldering conditions should be checked beforehand.</p>
Technical considerations	<p>◆Adjustment of mounting machine</p> <p>1. When installing products, care should be taken not to apply distortion stress as it may deform the products.</p>
4. Soldering	
Precautions	<p>◆Reflow soldering</p> <p>1. Please contact any of our offices for a reflow soldering, and refer to the recommended condition specified.</p> <p>2. The product shall be used reflow soldering only.</p> <p>3. Please do not add any stress to a product until it returns in normal temperature after reflow soldering.</p> <p>◆Lead free soldering</p> <p>1. When using products with lead free soldering, we request to use them after confirming adhesion, temperature of resistance to soldering heat, soldering etc sufficiently.</p>
Technical considerations	<p>◆Reflow soldering</p> <p>1. If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently degrade the reliability of the products.</p> <p>Recommended reflow condition (Pb free solder)</p> <p>Temperature [°C]</p> <p>Heating Time [sec]</p> <p>150~180</p> <p>90±30sec</p> <p>230°C min</p> <p>40sec max</p> <p>5sec max</p> <p>Peak: 260+0/-5°C</p>
5. Cleaning	
Precautions	<p>◆Cleaning conditions</p> <p>1. Washing by supersonic waves shall be avoided.</p>
Technical considerations	<p>◆Cleaning conditions</p> <p>1. If washed by supersonic waves, the products might be broken.</p>

6. Handling	
Precautions	<ul style="list-style-type: none"> ◆ Handling <ol style="list-style-type: none"> 1. Keep the product away from all magnets and magnetic objects. ◆ Breakaway PC boards (splitting along perforations) <ol style="list-style-type: none"> 1. When splitting the PC board after mounting product, care should be taken not to give any stresses of deflection or twisting to the board. 2. Board separation should not be done manually, but by using the appropriate devices. ◆ Mechanical considerations <ol style="list-style-type: none"> 1. Please do not give the product any excessive mechanical shocks. 2. Please do not add any shock and power to a product in transportation. ◆ Pick-up pressure <ol style="list-style-type: none"> 1. Please do not push to add any pressure to a winding part. Please do not give any shock and push into a ferrite core exposure part. ◆ Packing <ol style="list-style-type: none"> 1. Please avoid accumulation of a packing box as much as possible.
Technical considerations	<ul style="list-style-type: none"> ◆ Handling <ol style="list-style-type: none"> 1. There is a case that a characteristic varies with magnetic influence. ◆ Breakaway PC boards (splitting along perforations) <ol style="list-style-type: none"> 1. The position of the product on PCBs shall be carefully considered to minimize the stress caused from splitting of the PCBs. ◆ Mechanical considerations <ol style="list-style-type: none"> 1. There is a case to be damaged by a mechanical shock. 2. There is a case to be broken by the handling in transportation. ◆ Pick-up pressure <ol style="list-style-type: none"> 1. Damage and a characteristic can vary with an excessive shock or stress. ◆ Packing <ol style="list-style-type: none"> 1. If packing boxes are accumulated, that could cause a deformation on packing tapes or a damage on the products.
7. Storage conditions	
Precautions	<ul style="list-style-type: none"> ◆ Storage <ol style="list-style-type: none"> 1. To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled. <ul style="list-style-type: none"> ▪ Recommended conditions <ul style="list-style-type: none"> Ambient temperature : 0~40°C Humidity : Below 70% RH ▪ The ambient temperature must be kept below 30°C. Even under ideal storage conditions, solderability of products electrodes may decrease as time passes. <ul style="list-style-type: none"> For this reason, product should be used within 6 months from the time of delivery. In case of storage over 6 months, solderability shall be checked before actual usage.
Technical considerations	<ul style="list-style-type: none"> ◆ Storage <ol style="list-style-type: none"> 1. Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place.